

TLE9350XSJ

High speed CAN FD transceiver

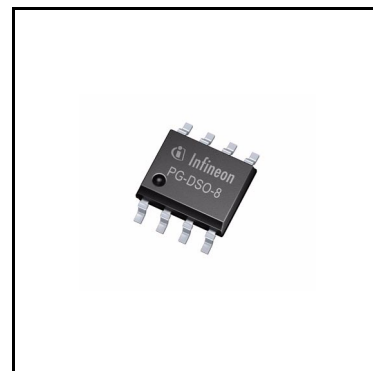


RoHS



Features

- Fully compliant to ISO 11898-2:2016 and SAE J2284-4/-5
- Loop delay symmetry for CAN FD data frames up to 5 MBit/s
- Certified according to VeLIO (Vehicle LAN Interoperability and Optimization) test requirements
- Very low electromagnetic emission (EME) allows the use without additional common mode choke
- V_{IO} input for voltage adaption to the microcontroller interface (3.3 V or 5 V)
- Excellent ESD robustness
- TxD time-out function
- Very low CAN bus leakage current in power-down state
- Overtemperature protection
- Protected against automotive transients according to ISO 7637 and SAE J2962-2
- Receive-only mode
- Green Product (RoHS compliant)



Potential applications

- Engine control units (ECU)
- Body control modules (BCM)
- Electric power steering
- Transmission control units (TCUs)
- Chassis control modules

Product validation

Qualified for automotive applications. Product validation according to AEC-Q100.

Description

The TLE9350XSJ is a high speed CAN transceiver, used in HS CAN systems for automotive applications as well as for industrial applications. It is designed to fulfill the requirements of ISO 11898-2:2016 physical layer specification as well as SAE J1939 and SAE J2284.

The TLE9350XSJ is available in a RoHS compliant, halogen free PG-DSO-8 package.

As an interface between the physical bus layer and the HS CAN protocol controller, the TLE9350XSJ is designed to protect the microcontroller against interferences generated inside the network. A very high ESD

robustness and the optimized RF immunity allows the use in automotive applications without additional protection devices, such as suppressor diodes or common mode chokes.

Based on the high symmetry of the CANH and CANL output signals, the TLE9350XSJ provides a very low level of electromagnetic emission (EME) within a wide frequency range. The TLE9350XSJ fulfills even stringent EMC test limits without an additional external circuit, such as a common mode choke.

The optimized transmitter symmetry combined with the optimized delay symmetry of the receiver enables the TLE9350XSJ to support CAN FD data frames. The device supports data transmission rates up to 5 MBit/s, depending on the size of the network and the inherent parasitic effects.

Fail-safe features, such as overtemperature protection, output current limitation or the TxD time-out feature are designed to protect the TLE9350XSJ and the external circuitry from irreparable damage.

Type	Package	Marking
TLE9350XSJ	PG-DSO-8	9350X

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1 Block diagram

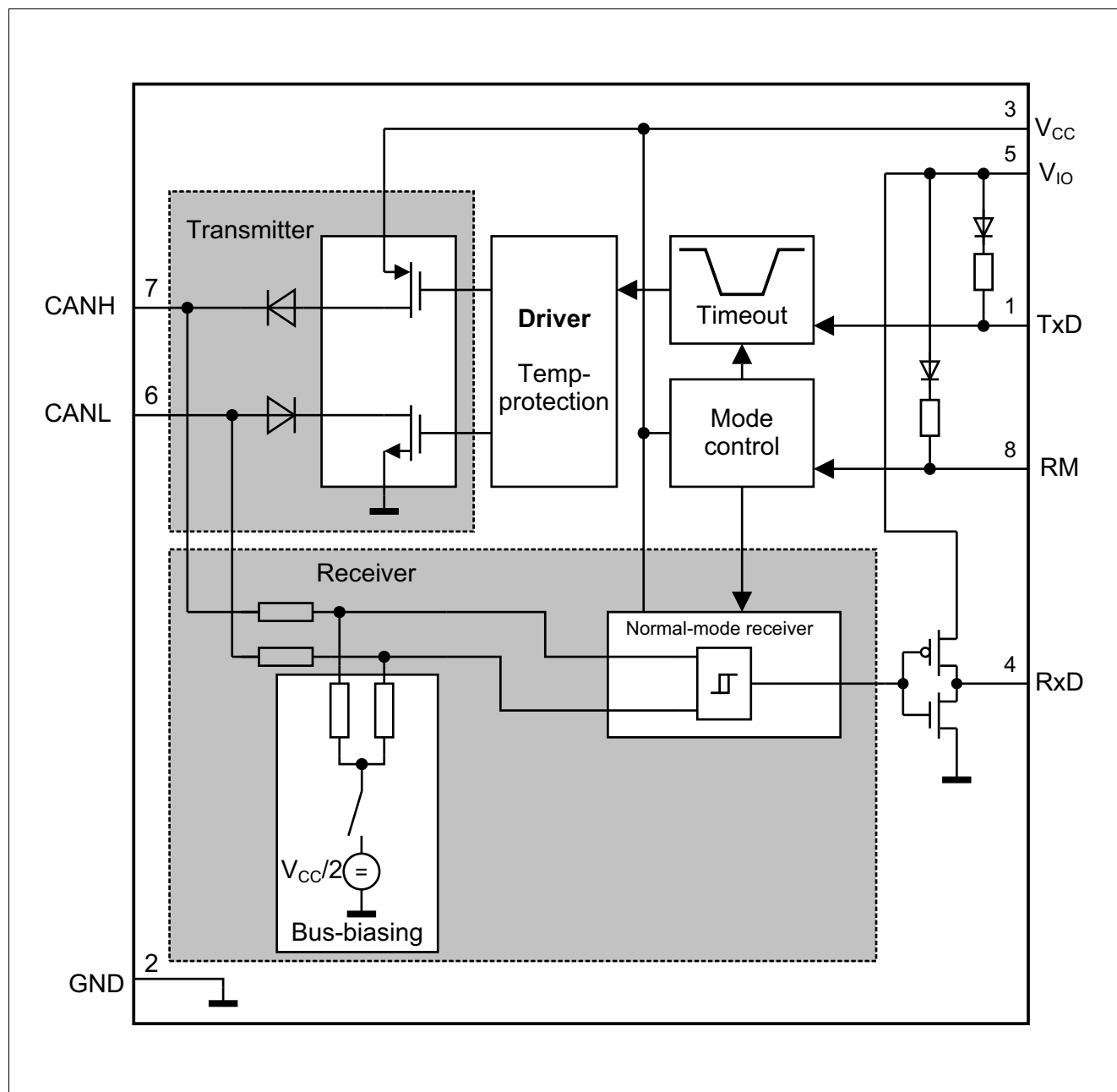


Figure 1 Block diagram

2 Pin configuration

2.1 Pin assignment

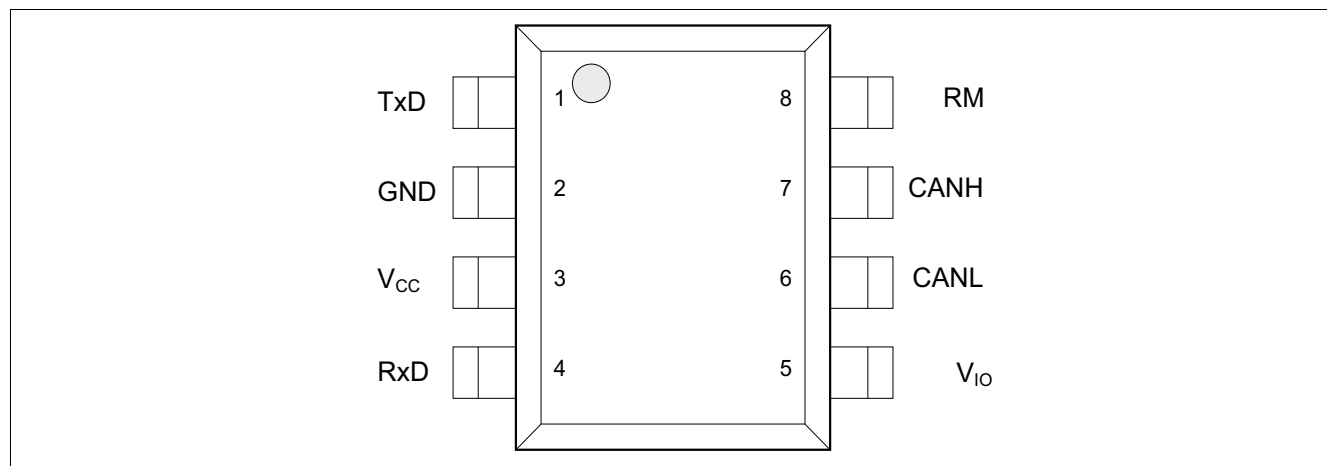


Figure 2 Pin configuration

2.2 Pin definitions

Table 1 Pin definitions and functions

Pin No.	Symbol	Function
1	TxD	Transmit data input; Internal pull-up to V _{IO} , "low" for dominant state.
2	GND	Ground
3	V _{CC}	Transmitter supply voltage; A decoupling capacitor of 1 µF to GND is recommended.
4	RxD	Receive data output; "Low" in dominant state.
5	V _{IO}	Digital supply voltage input; Adapts the logical input voltage level and output voltage level of the transceiver to the voltage level of the microcontroller supply, A 100 nF decoupling capacitor to GND is recommended.
6	CANL	CAN bus low level I/O; Bus level on the CANL input/output.
7	CANH	CAN bus high level I/O; Bus level on the CANH input/output.
8	RM	Receive-only input; Internal pull-up to V _{IO} , "low" for normal-operating mode.

3 General product characteristics

3.1 Absolute maximum ratings

Table 2 Absolute maximum ratings voltages, currents and temperatures¹⁾

All voltages with respect to ground; positive current flowing into pin;
(unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Voltages							
Transmitter supply voltage	V _{CC}	-0.3	–	6.0	V	–	P_7.1.1
Digital supply voltage	V _{IO}	-0.3	–	6.0	V	–	P_7.1.2
CANH and CANL DC voltage versus GND	V _{CANH}	-40	–	40	V	–	P_7.1.3
Differential voltage between CANH and CANL	V _{CAN_Diff}	-40	–	40	V	–	P_7.1.4
Voltage at the digital input pins: RM, TxD	V _{MAX_IO}	-0.3	–	6.0	V	–	P_7.1.5
Voltage at the digital output pin: RxD	V _{MAX_RxD}	-0.3	–	V _{IO} +0.3	V	–	P_7.1.9
Currents							
RxD output current	I _{RxD}	-5	–	5	mA	–	P_7.1.6
Temperatures							
Junction temperature	T _J	-40	–	150	°C	–	P_7.1.7
Storage temperature	T _S	-55	–	150	°C	–	P_7.1.8
ESD immunity							
ESD immunity at CANH, CANL versus GND	V _{ESD_HBM_CAN}	-10	–	10	kV	HBM; (100 pF via 1.5 kΩ) ²⁾	P_7.1.10
ESD immunity at all other pins	V _{ESD_HBM_ALL}	-2	–	2	kV	HBM; (100 pF via 1.5 kΩ) ²⁾	P_7.1.11
ESD immunity corner pins	V _{ESD_CDM_CP}	-750	–	750	V	CDM ³⁾	P_7.1.14
ESD immunity all other pins	V _{ESD_CDM_OP}	-500	–	500	V	CDM ³⁾	P_7.1.12

1) Not subject to production test, specified by design.

2) ESD susceptibility, Human Body Model (HBM) according to ANSI/ESDA/JEDEC JS-001.

3) ESD susceptibility, Charge Device Model (CDM) according to ANSI/ESDA/JEDEC JS-002.

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as outside normal-operating range. Protection functions are not designed for continuous repetitive operation.

3.2 Functional range

Table 3 Functional range

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Supply voltages							
Transmitter supply voltage	V _{CC}	4.75	–	5.25	V	–	P_7.2.1
Digital supply voltage	V _{IO}	3.0	–	5.5	V	–	P_7.2.2
Thermal parameters							
Junction temperature	T _j	-40	–	150	°C	1)	P_7.2.3

1) Not subject to production test, specified by design.

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

3.3 Thermal resistance

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, please visit www.jedec.org.

Table 4 Thermal resistance¹⁾

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Thermal resistance							
Junction to ambient PG-DSO-8	R_{thJA_DSO8}	–	120	–	K/W	2)	P_7.3.2
Thermal shutdown (junction temperature)							
Thermal shutdown temperature, rising	T_{JSD}	170	180	190	°C	temperature falling: minimum 150°C	P_7.3.3
Thermal shutdown hysteresis	ΔT	5	10	20	K		P_7.3.4

1) Not subject to production test, specified by design

2) Specified R_{thJA} value is according to JEDEC JESD51-2,-7 at natural convection on FR4 2s2p board. The product was simulated on a $76.2 \times 114.3 \times 1.5 \text{ mm}^3$ board with two inner copper layers ($2 \times 70\mu\text{m Cu}$, $2 \times 35\mu\text{m Cu}$).

4 High speed CAN functional description

HS CAN is a serial bus system that connects microcontrollers, sensors and actuators for real-time control applications. ISO 11898 describes the use of the Controller Area Network (CAN) within road vehicles. According to the 7-layer OSI reference model the physical layer of a HS CAN bus system specifies the data transmission from one CAN node to all other CAN nodes available within the network. The physical layer specification of a CAN bus system includes all electrical specifications of a CAN. The CAN transceiver is part of the physical layer specification.

4.1 High speed CAN physical layer

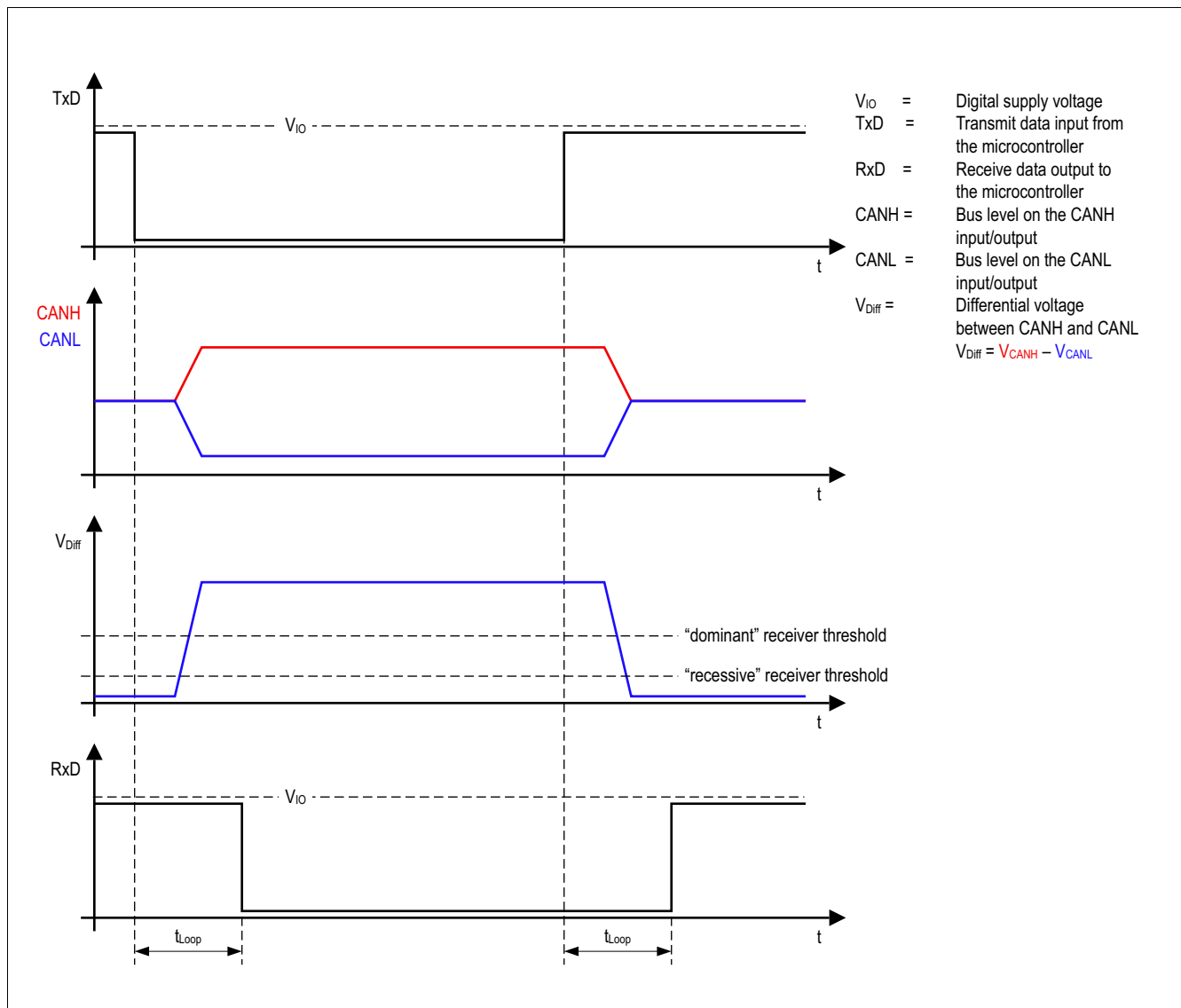


Figure 3 High speed CAN bus signals and logic signals

The TLE9350XSJ operates as an interface between the CAN controller and the physical bus medium. A HS CAN is a two wire differential network which allows data transmission rates up to 5 MBit/s. The characteristics for a HS CAN are the two signal states on the CAN bus: dominant and recessive (see [Figure 3](#)).

The CANH and CANL pins are the interface to the CAN bus and both pins operate as an input and output simultaneously. The RxD and TxD pins are the interface to the microcontroller. The pin TxD is the serial data input from the CAN controller, the RxD pin is the serial data output to the CAN controller. As shown in [Figure 1](#), the TLE9350XSJ includes a receiver and a transmitter unit, allowing the transceiver to send data to the bus medium and monitor the data from the bus medium at the same time. The TLE9350XSJ converts the serial data stream which is available on the transmit data input TxD, into a differential output signal on the CAN bus, provided by the CANH and CANL pins. The receiver stage of the TLE9350XSJ monitors the data on the CAN bus and converts them to a serial, single-ended signal on the RxD output pin. A "low" signal on the TxD pin creates a dominant signal on the CAN bus, followed by a logical "low" signal on the RxD pin (see [Figure 3](#)). The feature of broadcasting data to the CAN bus and listening to the data traffic on the CAN bus simultaneously is essential to support the bit-to-bit arbitration within CAN.

ISO 11898-2:2016 specifies the voltage levels for HS CAN transceivers. Whether a data bit is dominant or recessive depends on the voltage difference between the CANH and CANL pins ($V_{\text{Diff}} = V_{\text{CANH}} - V_{\text{CANL}}$).

To transmit a dominant signal to the CAN bus the amplitude of the differential signal V_{Diff} is higher than or equal to 1.5 V. To receive a recessive signal from the CAN bus the amplitude of the differential V_{Diff} is lower than or equal to 0.5 V.

In partially-supplied high speed CAN the bus nodes of one common network have different power supply conditions. Some nodes are connected to the power supply, while other nodes are disconnected from the power supply and in power-down state. Regardless of whether the CAN bus subscriber is supplied or not, each subscriber connected to the common bus media must not interfere with the communication. The TLE9350XSJ is designed to support partially-supplied networks. In power-down state, the receiver input resistors are switched off and the transceiver input has a high resistance.

The voltage level on the digital input TxD and the digital output RxD is determined by the power supply level at the V_{IO} pin. Depending on the voltage level at the V_{IO} pin, the signal levels on the logic pins (STB, TxD and RxD) are compatible with microcontrollers having a 5 V or 3.3 V I/O supply. Usually the digital power supply V_{IO} of the transceiver is connected to the I/O power supply of the microcontroller (see [Figure 12](#)).

5 Modes of operation

The TLE9350XSJ supports the following modes of operation):

- Normal-operating mode
- Receive-only mode

The mode selection input pin RM triggers mode changes. Undervoltage on V_{CC} disables the transmitter output stage. An undervoltage event on the digital supply V_{IO} powers down the device.

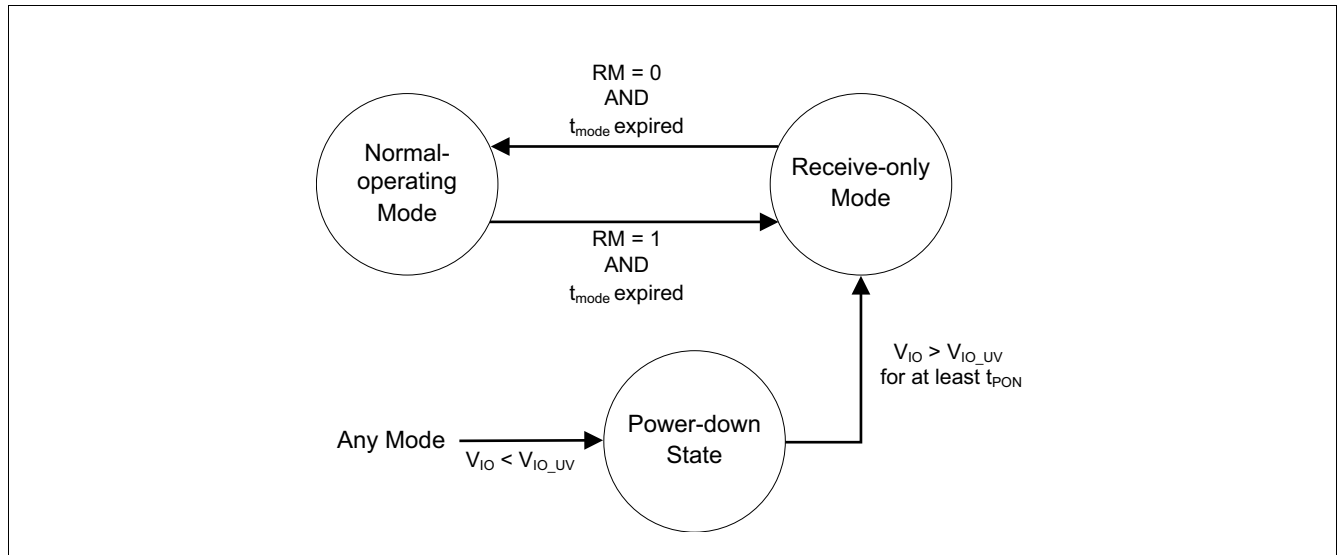


Figure 4 Mode state diagram

5.1 Normal-operating mode

In normal-operating mode all functions of the device are available and the device is fully functional. Data can be received from the HS CAN bus as well as transmitted to the HS CAN bus.

- The transmitter is enabled and drives the serial data stream on the TxD input pin to the bus pins CANH and CANL.
- The receiver is enabled and converts the signal from the bus to a serial data stream on the RxD output pin.
- The bus biasing is active.
- The TxD time-out function is enabled (see [Chapter 6.4](#)).
- The overtemperature protection is enabled (see [Chapter 6.6](#)).
- The undervoltage detection on V_{CC} and V_{IO} are enabled (see [Chapter 6.3](#) and [Chapter 5.3](#)).

The device enters normal-operating mode by setting the mode selection pin RM to "low", see [Figure 4](#). Normal-operating mode can be entered if the device supply V_{CC} is higher than V_{CC_UV} . The device enters normal-operating mode after t_{mode} expires.

Note: *If the device recognizes a recessive signal on the TxD input pin during a mode change from any mode to normal-operating mode, then it enables the transmit path after the mode change.
 If the device recognizes a dominant signal on the TxD input pin during a mode change to normal-operating mode, then it keeps the transmit path disabled and it blocks the dominant signal in order to not disturb the bus communication. As soon as the device recognizes a recessive signal on the TxD input pin, it enables the transmit path again.*

5.2 Receive-only mode

In receive-only mode the transmitter is disabled and the receiver is enabled. The TLE9350XSJ can receive data from the HS CAN bus, but cannot transmit data to the HS CAN bus.

- The transmitter is disabled and the data available on the TxD input is blocked.
- The receiver is enabled and converts the signal from the bus to a serial data stream on the RxD output pin.
- The bus biasing is connected to $V_{CC}/2$ for $V_{CC} > V_{CC_UV}$.
- The TxD time-out function is disabled.
- The undervoltage detection on V_{CC} and V_{IO} are enabled (see [Chapter 6.3](#) and [Chapter 5.3](#)).

If the mode selection pin RM is set to "high", then the TLE9350XSJ enters receive-only. V_{IO} must be higher than V_{IO_UV} as a prerequisite to enter receive-only mode. The device enters receive-only mode after t_{mode} expires.

5.3 Power-down State

If the supply voltage $V_{IO} < V_{IO_UV}$, then the device powers down independently of Independent of the transmitter supply V_{CC} and RM input pin (see [Figure 5](#)). In power-down state all functions of the device are disabled and the device is switched off. The input resistors of the receiver are disconnected. The CANH and CANL bus interface of the device is floating and acts as a high impedance input with a very low leakage current. The high impedance input does not influence the recessive level of the CAN and allows an optimized EME performance of the entire network. In power-down state the transceiver is an invisible node to the bus. t_{pon} must expire as a prerequisite for the device to exit power-down state.

- The transmitter and receiver are disabled.
- The bus biasing is connected to high impedance.
- The TxD time-out function is disabled.
- The overtemperature protection is disabled.
- The undervoltage detection on V_{CC} is disabled.
- The undervoltage detection on V_{IO} is enabled.

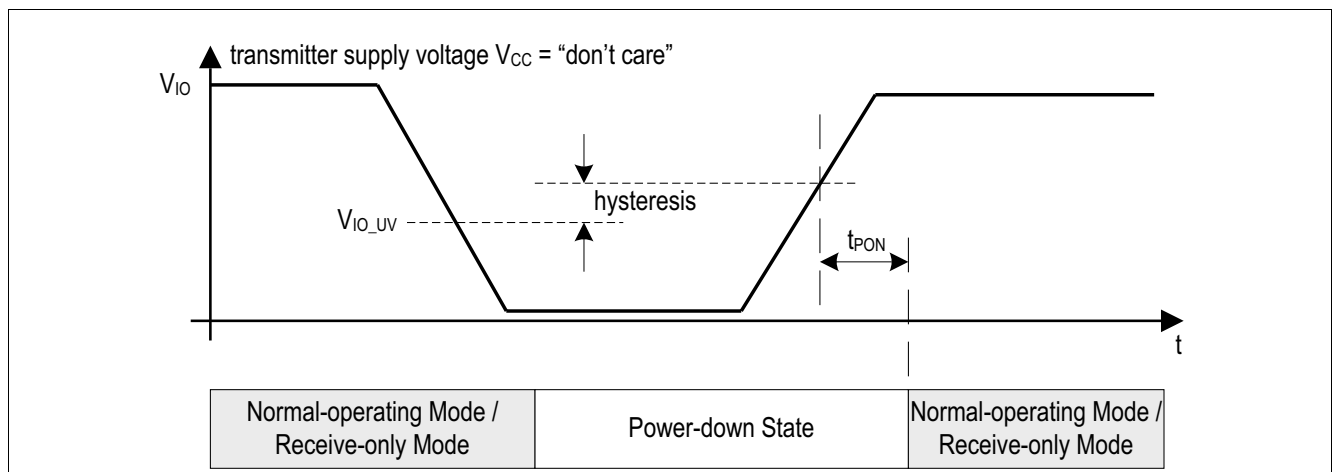


Figure 5 Power-down and power-up behavior and V_{IO}

6 Fail safe functions

6.1 Short circuit protection

The CANH and CANL bus outputs are short circuit proof to GND and short circuit proof to a supply voltage. The current limiting circuit is designed to protect the transceiver from damage. If the device heats up due to a continuous short on the CANH or CANL, then the internal overtemperature protection switches off the bus transmitter.

6.2 Unconnected logic pins

All logic input pins have an internal pull-up resistor to V_{IO} . If the V_{IO} and V_{CC} supply is active and the logical pins are open, the device enters the normal-operating mode by default.

6.3 V_{CC} undervoltage

If the transmitter supply is in undervoltage condition $V_{CC} < V_{CC_UV}$, then the device might not be able to provide the correct bus levels on the CANH and CANL output pins. During this time the transmitter is blocked in normal-operating mode, to avoid any interference with the network.

During undervoltage condition $V_{CC} < V_{CC_UV}$, the bus biasing is switched to ground in normal-operating mode and receive-only mode.

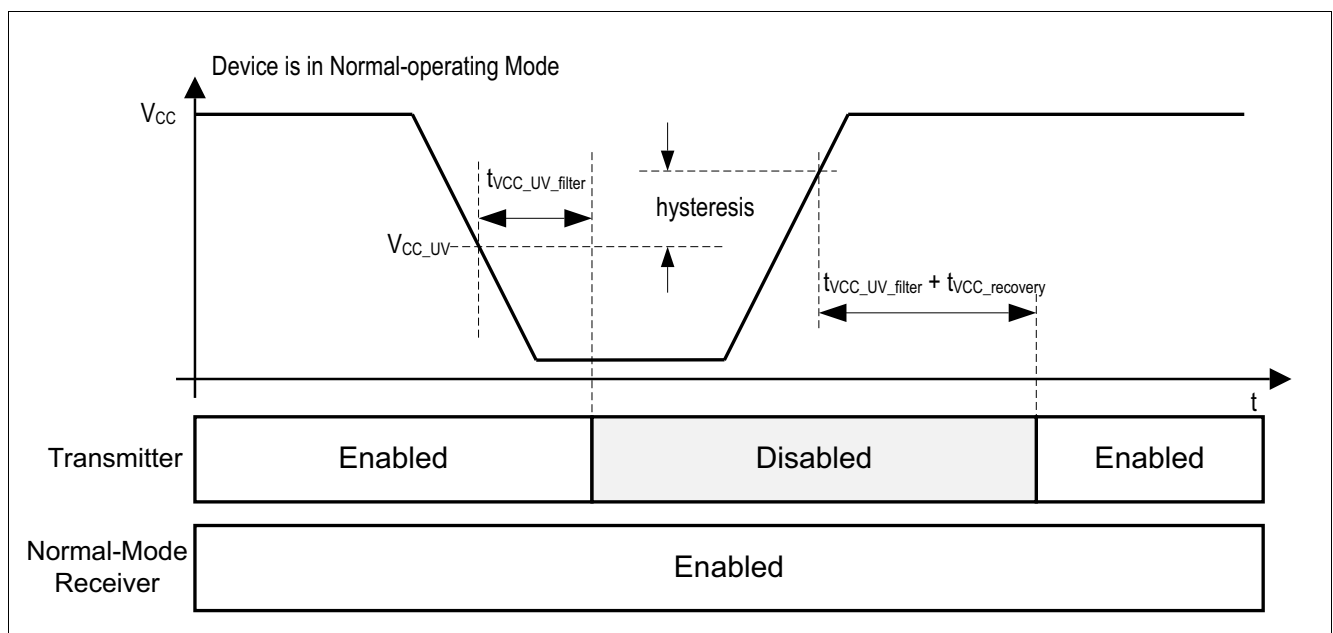


Figure 6 Undervoltage on the transmitter supply V_{CC}

6.4 TxD time-out feature

The TxD time-out feature protects the CAN bus against permanent blocking in case the logical signal on the TxD pin is continuously "low". A continuous "low" signal on the TxD pin might have its root cause in a locked-up microcontroller or in a short circuit on the printed circuit board, for example.

In normal-operating mode, a "low" signal on the TxD pin for the time $t > t_{TxD}$ enables the TxD time-out feature and the device disables the transmitter (see [Figure 7](#)). The receiver is still active and the device continues to monitor data on the bus via the RxD output pin.

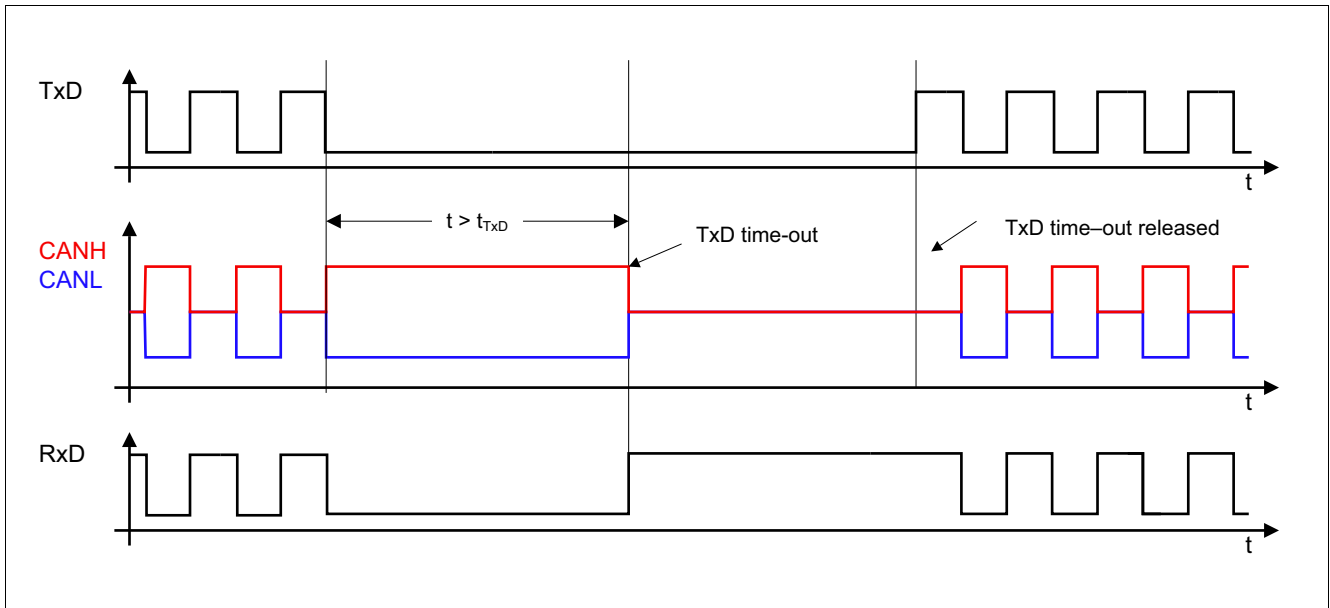


Figure 7 TxD time-out function

Figure 7 shows how the transmitter is deactivated and activated again. A permanent "low" signal on the TxD input pin activates the TxD time-out and deactivates the transmitter. To release the transmitter after a TxD time-out event, the device requires a signal change on the TxD input pin from "low" to "high".

6.5 Delay time for mode change

The device changes the mode of operation within the time window t_{Mode} .

6.6 Overtemperature protection

The TLE9350XSJ has an integrated overtemperature detection, which is designed to protect the device against thermal overstress of the transmitter. The overtemperature protection is only active in normal-operating mode. In case of an overtemperature condition, the temperature sensor disables the transmitter while the transceiver remains in normal-operating mode. After the device cools down it enables the transmitter again (see **Figure 8**). A hysteresis is implemented within the temperature sensor.

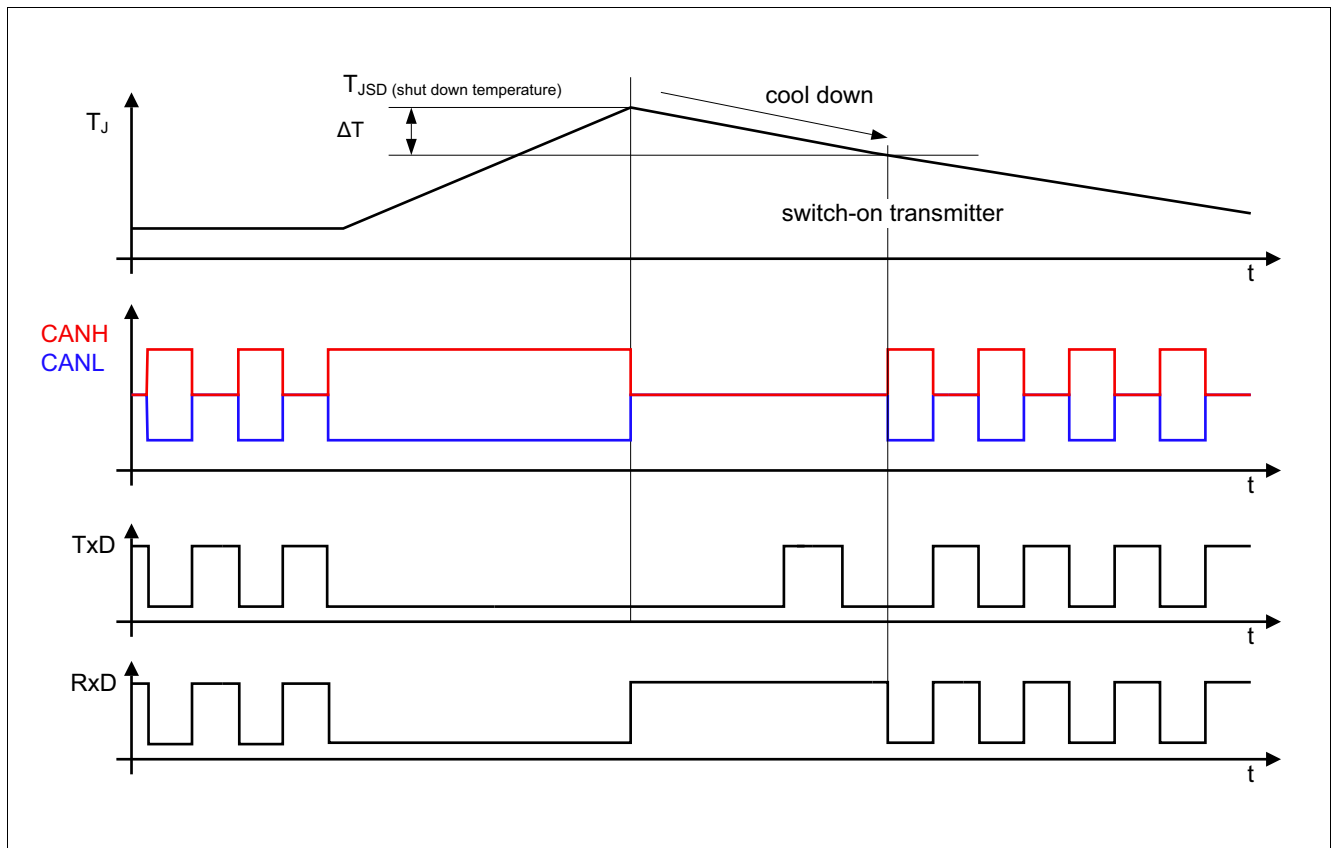


Figure 8 **Overtemperature protection**

7 Electrical characteristics

7.1 Power supply interface

7.1.1 Electrical characteristics current consumption

Table 5 Electrical characteristics current consumption

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Current consumption at V_{CC} normal-operating mode, recessive state	I_{CC_R}	–	1.4	4	mA	$V_{TxD} = V_{IO}$; $V_{RM} = 0 \text{ V}$; $V_{CANH} = V_{CANL} = V_{CC}/2$	P_8.1.1
Current consumption at V_{CC} normal-operating mode, dominant state	I_{CC_D}	–	34	48	mA	$V_{TxD} = V_{RM} = 0 \text{ V}$	P_8.1.2
Current consumption at V_{IO} normal-operating mode	I_{IO}	–	0.9	1.5	mA	$V_{RM} = 0 \text{ V}$; $V_{Diff} = 0 \text{ V}$; recessive	P_8.1.3
Current consumption at V_{CC} receive-only mode	$I_{CC(ROM)}$	–	0.2	1	mA	$V_{RM} = V_{IO}$	P_8.1.9
Current consumption at V_{IO} receive-only mode	$I_{IO(ROM)}$	–	0.8	1.5	mA	$V_{RM} = V_{IO}$	P_8.1.10

7.1.2 Electrical characteristics undervoltage detection

Table 6 Electrical characteristics undervoltage detection

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
V_{CC} undervoltage threshold	V_{CC_UV}	3.8	4.2	4.65	V	see Figure 6	P_8.1.11
V_{CC} undervoltage delay time	$t_{VCC_UV_filter}$	–	6	30	μs	¹⁾ see Figure 6	P_8.1.13
V_{CC} undervoltage recovery time	$t_{VCC_recovery}$	–	7	70	μs	¹⁾ see Figure 6	P_8.1.14
V_{IO} undervoltage threshold	V_{IO_UV}	2.0	2.6	3.0	V	–	P_8.1.15
V_{IO} delay time power-up	t_{PON}	–	40	280	μs	¹⁾ see Figure 5	P_8.1.19

1) Not subject to production test, specified by design.

7.2 Electrical characteristics CAN controller interface

Table 7 Electrical characteristics CAN controller interface

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Receiver output RxD							
"High" level output current	$I_{\text{RxD_H}}$	–	-2.5	-1	mA	$V_{\text{RxD}} = V_{\text{IO}} - 0.4 \text{ V}$; $V_{\text{Diff}} < 0.5 \text{ V}$	P_8.2.1
"Low" level output current	$I_{\text{RxD_L}}$	1	2.5	–	mA	$V_{\text{RxD}} = 0.4 \text{ V}$; $V_{\text{Diff}} > 0.9 \text{ V}$	P_8.2.2
Transmission input TxD							
"High" level input voltage	$V_{\text{TxD_H}}$	$0.7 \times V_{\text{IO}}$	–	6.0	V	recessive state	P_8.2.3
"Low" level input voltage	$V_{\text{TxD_L}}$	-0.3	–	$0.3 \times V_{\text{IO}}$	V	dominant state	P_8.2.4
Internal pull-up resistor TxD	R_{TxD}	35	55	70	kΩ	–	P_8.2.7
Input capacitance	C_{TxD}	–	–	10	pF	¹⁾	P_8.2.8
TxD permanent dominant time-out	t_{TxD}	1	2.3	4	ms	normal-operating mode	P_8.2.9
Receive-only input RM							
"High" level input voltage	$V_{\text{RM_H}}$	$0.7 \times V_{\text{IO}}$	–	6.0	V	receive-only mode	P_8.2.13
"Low" level input voltage	$V_{\text{RM_L}}$	-0.3	–	$0.3 \times V_{\text{IO}}$	V	normal-operating mode	P_8.2.14
Internal pull-up resistor RM	R_{RM}	35	55	70	kΩ	–	P_8.2.17
Input capacitance	$C_{(\text{RM})}$	–	–	10	pF	¹⁾	P_8.2.20

1) Not subject to production test, specified by design.

7.3 Electrical characteristics receiver

Table 8 Electrical characteristics receiver

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Differential range dominant normal-operating mode	$V_{\text{Diff_D_Range}}$	0.9	–	8.0	V	¹⁾ $-12 \text{ V} \leq V_{\text{CMR}} \leq 12 \text{ V}$	P_8.3.3
Differential range recessive normal-operating mode	$V_{\text{Diff_R_Range}}$	-3.0	–	0.5	V	¹⁾ $-12 \text{ V} \leq V_{\text{CMR}} \leq 12 \text{ V}$	P_8.3.5
Common mode range	CMR	-12	–	12	V	–	P_8.3.11
Single ended internal resistance	$R_{\text{CAN_H}}, R_{\text{CAN_L}}$	6	40	50	k Ω	¹⁾ recessive state; $-2 \text{ V} \leq V_{\text{CANH}} \leq 7 \text{ V}$; $-2 \text{ V} \leq V_{\text{CANL}} \leq 7 \text{ V}$	P_8.3.12
Differential internal resistance	R_{Diff}	12	80	100	k Ω	¹⁾ recessive state; $-2 \text{ V} \leq V_{\text{CANH}} \leq 7 \text{ V}$; $-2 \text{ V} \leq V_{\text{CANL}} \leq 7 \text{ V}$	P_8.3.14
Input resistance deviation between CANH and CANL	ΔR_i	-3	–	3	%	¹⁾ recessive state; $V_{\text{CANH}} = V_{\text{CANL}} = 5 \text{ V}$	P_8.3.16
Input capacitance CANH, CANL versus GND	C_{In}	–	–	40	pF	¹⁾²⁾ recessive state; normal-operating mode	P_8.3.17
Differential input capacitance	C_{InDiff}	–	4	20	pF	¹⁾²⁾ recessive state; normal-operating mode	P_8.3.18

1) Not subject to production test, specified by design.

2) S2P-Method; $f = 10 \text{ MHz}$.

7.4 Electrical characteristics transmitter

Table 9 Electrical characteristics transmitter

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
CANL, CANH recessive output voltage normal-operating mode	$V_{CANL,H}$	2.0	2.5	3.0	V	$V_{TxD} = V_{IO}$; no load	P_8.4.1
CANH, CANL recessive output voltage difference normal-operating mode	$V_{Diff_R_NM} = V_{CANH} - V_{CANL}$	-500	-10	50	mV	$V_{TxD} = V_{IO}$; no load	P_8.4.2
CANL dominant output voltage normal-operating mode	V_{CANL}	0.5	1.5	2.25	V	$V_{TxD} = 0 \text{ V}$; $50 \Omega < R_L < 65 \Omega$	P_8.4.3
CANH dominant output voltage normal-operating mode	V_{CANH}	2.75	3.4	4.5	V	$V_{TxD} = 0 \text{ V}$; $50 \Omega < R_L < 65 \Omega$	P_8.4.4
Differential voltage dominant normal-operating mode $V_{Diff} = V_{CANH} - V_{CANL}$	$V_{Diff_D_NM}$	1.5	1.9	2.5	V	$V_{TxD} = 0 \text{ V}$; $50 \Omega < R_L < 65 \Omega$	P_8.4.5
Differential voltage dominant extended bus load normal-operating mode	$V_{Diff_EXT_BL}$	1.4	1.9	3.3	V	$V_{TxD} = 0 \text{ V}$; $45 \Omega < R_L < 70 \Omega$	P_8.4.6
Differential voltage dominant high extended bus load normal-operating mode	$V_{Diff_HEXT_BL}$	1.5	3.5	5.0	V	¹⁾ $V_{TxD} = 0 \text{ V}$; $R_L = 2240 \Omega$; static behavior	P_8.4.7
Driver symmetry ($V_{SYM} = V_{CANH} + V_{CANL}$)	V_{SYM}	$0.9 \times V_{CC}$	$1.0 \times V_{CC}$	$1.1 \times V_{CC}$	V	^{1) 2)} $C_1 = 4.7 \text{ nF}$	P_8.4.10
CANL short circuit current	I_{CANLsc}	-115	90	115	mA	¹⁾ $-3 \text{ V} < V_{CANLshort} < 18 \text{ V}$; $t < t_{TxD}$; $V_{TxD} = 0 \text{ V}$	P_8.4.11
CANH short circuit current	I_{CANHsc}	-115	-90	115	mA	¹⁾ $-3 < V_{CANHshort} < 18 \text{ V}$; $t < t_{TxD}$; $V_{TxD} = 0 \text{ V}$	P_8.4.13
Leakage current, CANH	$I_{CANH,ik}$	-5	1	5	μA	$V_{CC} = V_{IO} = 0 \text{ V}$; $0 \text{ V} < V_{CANH} \leq 5 \text{ V}$; $V_{CANH} = V_{CANL}$	P_8.4.19
Leakage current, CANL	$I_{CANL,ik}$	-5	1	5	μA	$V_{CC} = V_{IO} = 0 \text{ V}$; $0 \text{ V} < V_{CANL} \leq 5 \text{ V}$; $V_{CANH} = V_{CANL}$	P_8.4.20

Table 9 Electrical characteristics transmitter (Continued)

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
CANH, CANL output voltage difference slope, recessive to dominant	$V_{\text{diff_slope_rd}}$	–	42	70	V/ μs	¹⁾ 30% to 70% of measured differential bus voltage, $C_2 = 100 \text{ pF}$, $R_L = 60 \Omega$, 4.75 V < V_{CC} < 5.25 V	P_8.4.21
CANH, CANL output voltage difference slope, dominant to recessive	$V_{\text{diff_slope_dr}}$	–	42	70	V/ μs	¹⁾ 70% to 30% of measured differential bus voltage, $C_2 = 100 \text{ pF}$, $R_L = 60 \Omega$, 4.75 V < V_{CC} < 5.25 V	P_8.4.22

1) Not subject to production test, specified by design.

2) V_{SYM} is observed during dominant and recessive state and also during the transition from dominant to recessive state and vice versa, while TxD is stimulated by a square wave signal with a frequency of 1 MHz.

7.5 Electrical characteristics dynamic transceiver parameters

Table 10 Electrical characteristics dynamic transceiver parameters

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Propagation delay TxD-to-RxD	t_{Loop}	80	150	255	ns	$C_1 = 0 \text{ pF}$, $C_2 = 100 \text{ pF}$, $C_{\text{RxD}} = 15 \text{ pF}$; (see Figure 10)	P_8.5.1
Propagation delay increased load TxD-to-RxD	$t_{\text{Loop}_{150}}$	80	180	330	ns	$C_1 = 0 \text{ pF}$, $C_2 = 100 \text{ pF}$, $C_{\text{RxD}} = 15 \text{ pF}$, $R_L = 150 \Omega$ ¹⁾	P_8.5.2
Propagation delay TxD to bus "low" to dominant	$t_{\text{d(L)_T}}$	30	70	140	ns	$C_1 = 0 \text{ pF}$, $C_2 = 100 \text{ pF}$, $C_{\text{RxD}} = 15 \text{ pF}$; (see Figure 10)	P_8.5.3
Propagation delay TxD to bus "high" to recessive	$t_{\text{d(H)_T}}$	30	90	140	ns	$C_1 = 0 \text{ pF}$, $C_2 = 100 \text{ pF}$, $C_{\text{RxD}} = 15 \text{ pF}$; (see Figure 10)	P_8.5.4
Propagation delay bus to RxD dominant to "low"	$t_{\text{d(L)_R}}$	30	90	140	ns	$C_{\text{RxD}} = 15 \text{ pF}$, Independent of t_{Bit} ; (see Figure 10)	P_8.5.5
Propagation delay bus to RxD recessive to "high"	$t_{\text{d(H)_R}}$	30	100	140	ns	$C_{\text{RxD}} = 15 \text{ pF}$, Independent of t_{Bit} ; (see Figure 10)	P_8.5.6

Delay Times

Delay time for mode change	t_{Mode}	–	12	20	μs	¹⁾	P_8.5.7
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CAN FD characteristics

Received recessive bit width at 2 MBit/s	$t_{\text{Bit(RxD)_2M}}$	420	450	520	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 500 \text{ ns}$; see Figure 11	P_8.5.13
Received recessive bit width at 5 MBit/s	$t_{\text{Bit(RxD)_5M}}$	120	150	220	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 200 \text{ ns}$; see Figure 11	P_8.5.14
Transmitted recessive bit width at 2 MBit/s	$t_{\text{Bit(Bus)_2M}}$	455	470	510	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 500 \text{ ns}$; see Figure 11	P_8.5.15

Table 10 Electrical characteristics dynamic transceiver parameters (Continued)

4.75 V < V_{CC} < 5.25 V; 3.0 V < V_{IO} < 5.5 V; $R_L = 60 \Omega$; $-40^\circ\text{C} < T_j < 150^\circ\text{C}$; all voltages with respect to ground; positive current flowing into pin; unless otherwise specified.

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Transmitted recessive bit width at 5 MBit/s	$t_{\text{Bit(Bus)}_5\text{M}}$	155	170	210	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 200 \text{ ns}$; see Figure 11	P_8.5.16
Receiver timing symmetry at 2 MBit/s $\Delta t_{\text{Rec_2M}} = t_{\text{Bit(RxD)}_2\text{M}} - t_{\text{Bit(Bus)}_2\text{M}}$	$\Delta t_{\text{Rec_2M}}$	-45	-23	15	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 500 \text{ ns}$; see Figure 11	P_8.5.17
Receiver timing symmetry at 5 MBit/s $\Delta t_{\text{Rec_5M}} = t_{\text{Bit(RxD)}_5\text{M}} - t_{\text{Bit(Bus)}_5\text{M}}$	$\Delta t_{\text{Rec_5M}}$	-45	-23	15	ns	$C_2 = 100 \text{ pF}$; $C_{\text{RxD}} = 15 \text{ pF}$; $t_{\text{Bit}} = 200 \text{ ns}$; see Figure 11	P_8.5.18

1) Not subject to production test, specified by design.

7.6 Diagrams

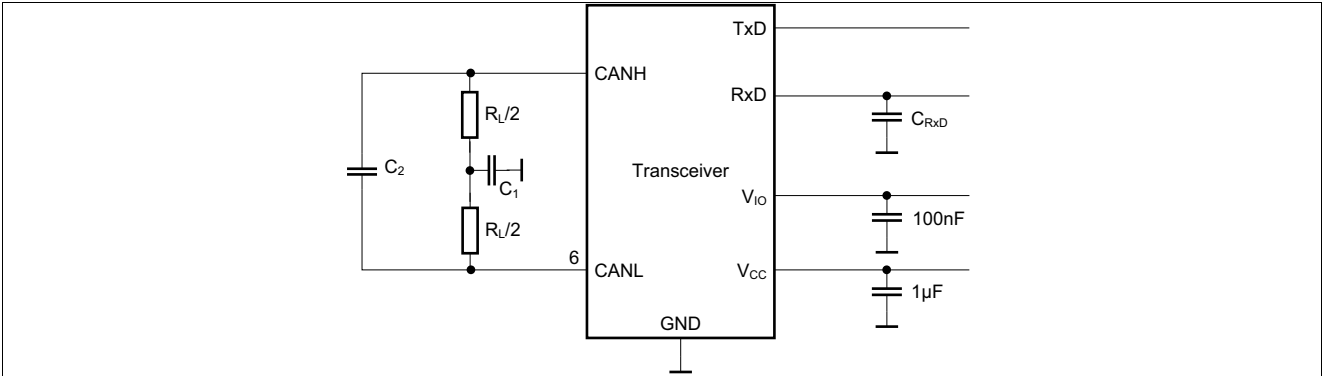


Figure 9 Test circuit

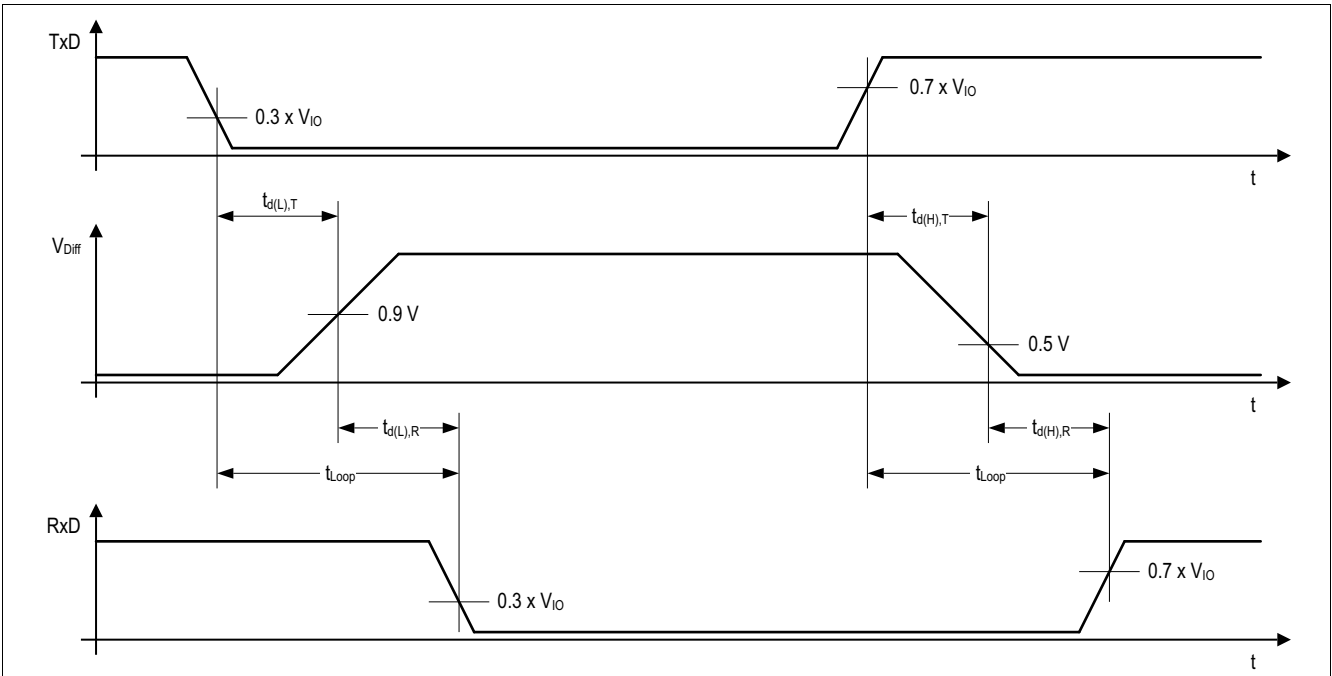


Figure 10 Timing diagrams for dynamic characteristics

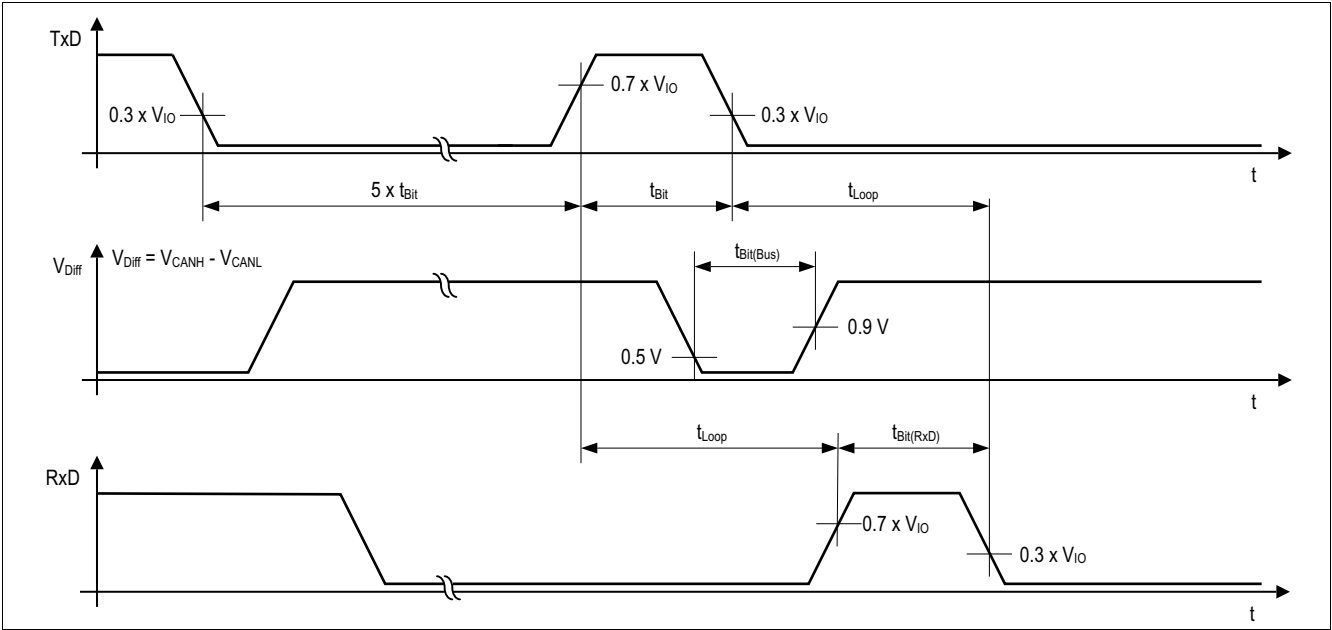


Figure 11 Recessive bit time for five dominant bits followed by one recessive bit

8.3 Voltage adaption to the microcontroller supply

To adapt the digital input and output levels of the device to the I/O levels of the microcontroller, connect the power supply pin V_{IO} to the microcontroller voltage supply, see [Figure 12](#).

Note: If case no dedicated digital supply voltage V_{IO} is required in the application, then connect the digital supply voltage V_{IO} to the transmitter supply V_{CC} .

8.4 Further application information

For further information you may visit: <https://www.infineon.com/automotive-transceiver>

9 Package information

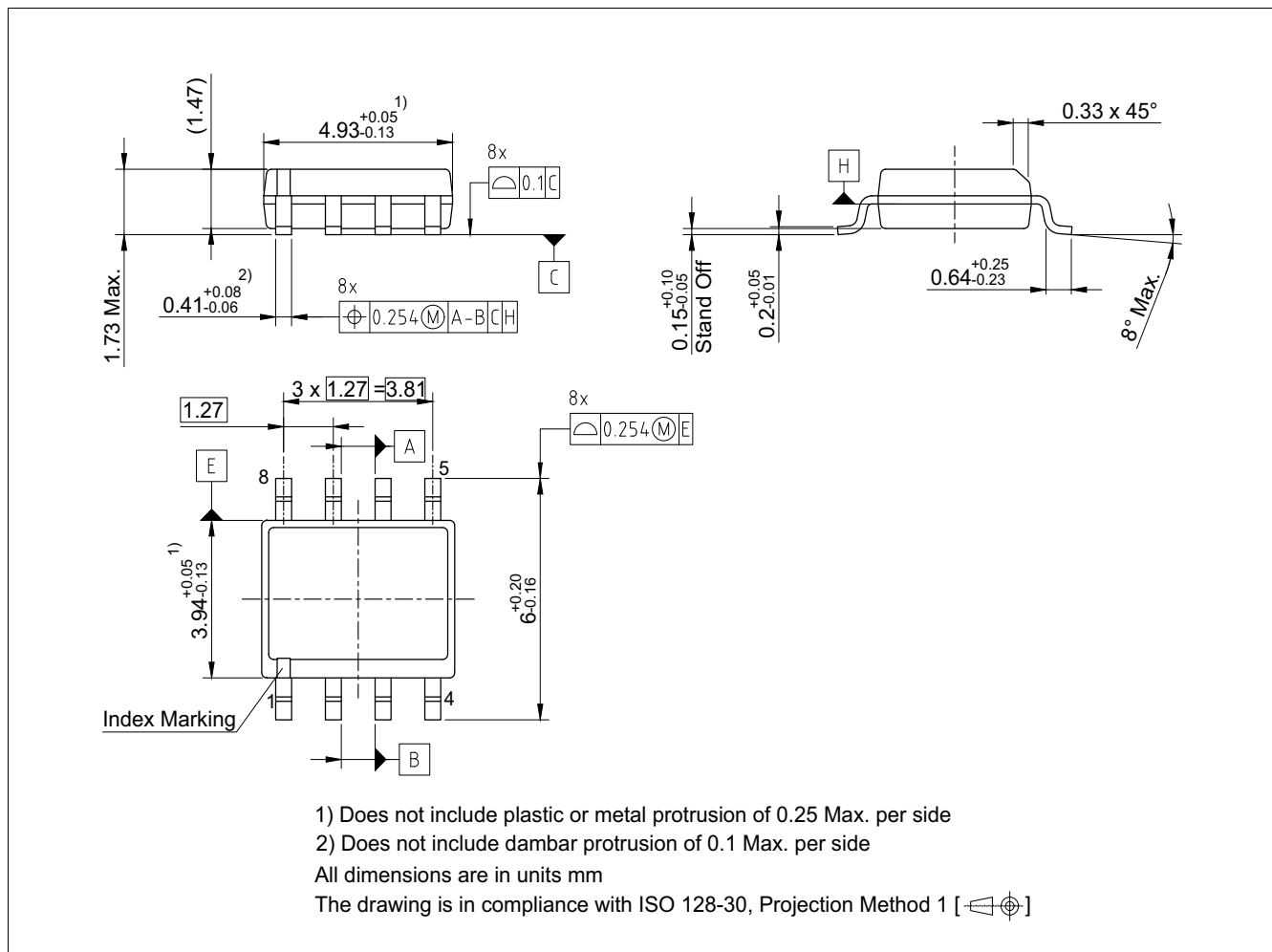


Figure 13 PG-DSO-8

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e. Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Further information on packages

<https://www.infineon.com/packages>

10 Revision history

Revision	Date	Changes
1.0	2020-11-06	Datasheet created

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